# UNISONIC TECHNOLOGIES CO., LTD

13N50-CB **Preliminary** Power MOSFET

## 13A, 500V N-CHANNEL **POWER MOSFET**

#### DESCRIPTION

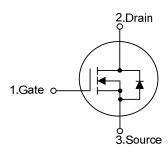
The UTC 13N50-CB is a N-Channel enhancement mode power MOSFET. The device adopts planar stripe and uses DMOS technology to minimize and provide lower on-state resistance and faster switching speed. It can also withstand high energy pulse under the avalanche and commutation mode conditions.

The UTC 13N50-CB is ideally suitable for high efficiency switch mode power supply, power factor correction, electronic lamp ballast based on half bridge topology.



- \*  $R_{DS(ON)}$  < 0.5  $\Omega$  @  $V_{GS}$  = 10V,  $I_{D}$  = 6.5 A
- \* Fast switching capability
- \* Avalanche energy tested
- \* Improved dv/dt capability, high ruggedness

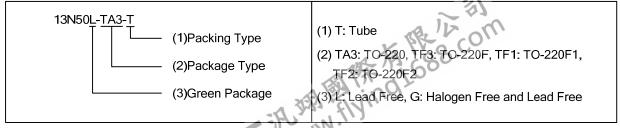
#### **SYMBOL**



#### ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
13N50L-TA3-T	13N50G-TA3-T	TO-220	G	D	S	Tube	
13N50L-TF1-T	13N50G-TF1-T	TO-220F1	G	D	S	Tube	
13N50L-TF3-T	3N50L-TF3-T 13N50G-TF3-T		G	D	S	Tube	
13N50L-TF3-T	13N50G-TF3-T	TO-220F	G	D	S	Tube	

Note: Pin Assignment: G: Gate S: Source D: Drain



www.unisonic.com.tw 1 of 7

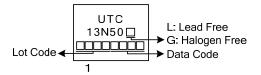
TO-220F

TO-220F2

TO-220

TO-220F1

## **MARKING**





## ■ ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	500	V
Gate-Source Voltage		$V_{GSS}$	±30	V
Drain Current	Continuous	I <sub>D</sub>	13	Α
	Pulsed (Note 2)	I <sub>DM</sub>	52	Α
Avalanche Current (Note 3)		I <sub>AR</sub>	5.4	Α
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	146	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	1.9	V/ns
Power Dissipation	TO-220		168	W
	TO-220F/TO-220F1 TO-220F2	$P_D$	48	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T <sub>STG</sub>	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 10mH,  $I_{AS}$  = 5.4A,  $V_{DD}$  = 50V,  $R_{G}$ = 25 $\Omega$  , Starting  $T_{J}$  = 25 $^{\circ}$ C
- 4.  $I_{SD} \le 13A$ , di/dt  $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25$ °C

#### **■ THERMAL DATA**

PARAMETER	PACKAGE	SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2	$\theta_{JA}$	62.5	°C/W
	TO-220		0.74	°C/W
Junction to Case	TO-220F/TO-220F1 TO-220F2	$\theta_{JC}$	2.6	°C/W



## ■ **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> =25°C, unless otherwise specified)

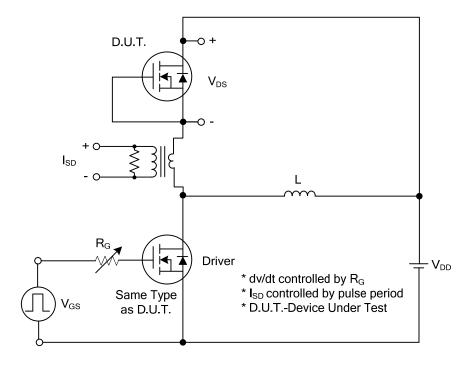
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS	_		ā.		ā.			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	$V_{GS} = 0V, I_D = 250\mu A$	500			V		
Drain-Source Leakage Current	I <sub>DSS</sub>	$V_{DS} = 500V, V_{GS} = 0V$			1	μΑ		
Cata Sauraa Laakaga Current	I <sub>GSS</sub>	$V_{GS} = 30V, V_{DS} = 0V$			100	nA		
Gate-Source Leakage Current		$V_{GS} = -30V, V_{DS} = 0V$			-100	nA		
ON CHARACTERISTICS	_		ā.		ē.			
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V		
Static Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	$V_{GS} = 10V, I_D = 6.5A$			0.5	Ω		
DYNAMIC CHARACTERISTICS	_		ā.		ē.			
Input Capacitance	C <sub>ISS</sub>	\\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		1600		pF		
Output Capacitance	Coss	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V,		160		pF		
Reverse Transfer Capacitance	C <sub>RSS</sub>	f=1.0MHz		29		pF		
SWITCHING CHARACTERISTICS			_	_	_			
Total Gate Charge (Note 1)	$Q_G$	V <sub>DS</sub> =50V, V <sub>GS</sub> =10V, I <sub>D</sub> =1.3A		80		nC		
Gate-Source Charge	$Q_{GS}$	, ,		7.5		nC		
Gate-Drain Charge	$Q_{GD}$	-I <sub>G</sub> =100μA (Note 1, 2)		5.5		nC		
Turn-On Delay Time (Note 1)	t <sub>D(ON)</sub>			61		nS		
Turn-On Rise Time	t <sub>R</sub>	$V_{DD}$ =30V, $V_{GS}$ =10V, $I_{D}$ =0.5A,		26		nS		
Turn-Off Delay Time	t <sub>D(OFF)</sub>	$R_G = 25\Omega$ (Note 1, 2)		264		nS		
Turn-Off Fall Time	t <sub>F</sub>	7		21		nS		
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS								
Maximum Body-Diode Continuous Current	Is				13	Α		
Maximum Body-Diode Pulsed Current (Note 1)	I <sub>SM</sub>				52	Α		
Drain-Source Diode Forward Voltage (Note 1)	$V_{SD}$	I <sub>S</sub> =13A, V <sub>GS</sub> = 0V			1.4	V		
Body Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>S</sub> =13A, V <sub>GS</sub> =0V,		270		ns		
Body Diode Reverse Recovery Charge	Qrr	dI <sub>F</sub> /dt=100A/μs		2.25		μC		

Notes: 1. Pulse Test : Pulse width≤300µs, Duty cycle≤2%

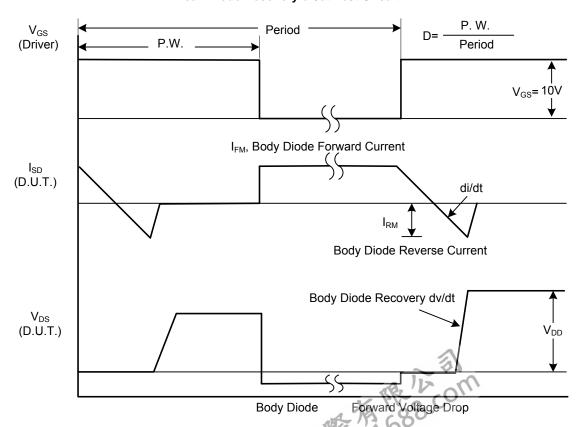
2. Essentially independent of operating ambient temperature



## **■ TEST CIRCUITS AND WAVEFORMS**

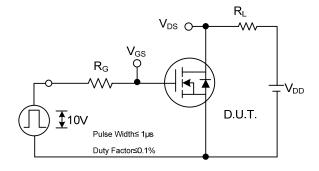


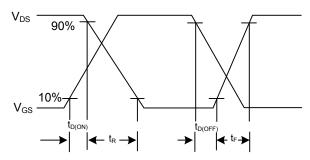
## Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

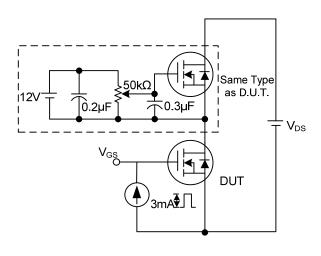
## **TEST CIRCUITS AND WAVEFORMS (Cont.)**

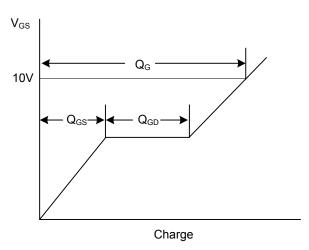




**Switching Test Circuit** 

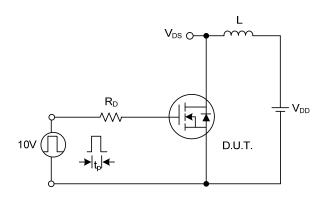
**Switching Waveforms** 

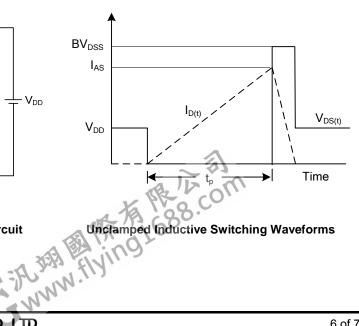




**Gate Charge Test Circuit** 

**Gate Charge Waveform** 





**Unclamped Inductive Switching Test Circuit** 

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